

SID

Factory: Rot am See

Article:

682

ML8

Provided:

Stockburger, Olesja

Customer:

Date:

26.01.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	210		2
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		3
C-RS-FR4-ML-0.51mm-105+105-TG150-HF	50200884	105	L2	4
		510		
		105	L3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	230		5
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		6
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		7
C-RS-FR4-ML-0.51mm-105+105-TG150-HF	50200884	105	L4	8
		510		
		105	L5	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	230		9
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		10
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		11
C-RS-FR4-ML-0.51mm-105+105-TG150-HF	50200884	105	L6	12
		510		
		105	L7	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	210		13
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		14
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	15

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

3110 µm

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